

Supplementary Materials

Cu_{2-x}S and Cu_{2-x}Se Alloys: Investigating the Influence of Ag, Zn, and Ni Doping on Structure and Transport Behavior

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Table S1. Density of copper (I) chalcogenide sinters.

Material	Density [g cm ⁻¹]	Material	Density [g cm ⁻¹]
Cu_{1.97}S	5.51	Cu_{1.8}Se	6.10
Cu_{1.96}Ag_{0.01}S	5.37	Cu_{1.79}Ag_{0.01}Se	6.13
Cu_{1.96}Ni_{0.01}S	5.54	Cu_{1.79}Ni_{0.01}Se	6.06
Cu_{1.96}Zn_{0.01}S	5.49	Cu_{1.79}Zn_{0.01}Se	6.04

Table S2. Unit cell parameters together with fitting parameters for Cu_{1.97}S and Cu_{1.8}Se sintered pellets.

Structural parameter	This work	Reference card	GoF [-]	wRp [-]
Cu_{1.97}S – Reference card Cu₂S (ICDD 01-083-1462)				
a [Å]	15.229	15.246	3.26	14.31
b [Å]	11.882	11.884		
c [Å]	13.495	13.494		
β [°]	116.266	116.350		
Cu_{1.8}Se – Reference card (ICSD 98-015-0759)				
a [Å]	5.754	5.750	3.72	8.10

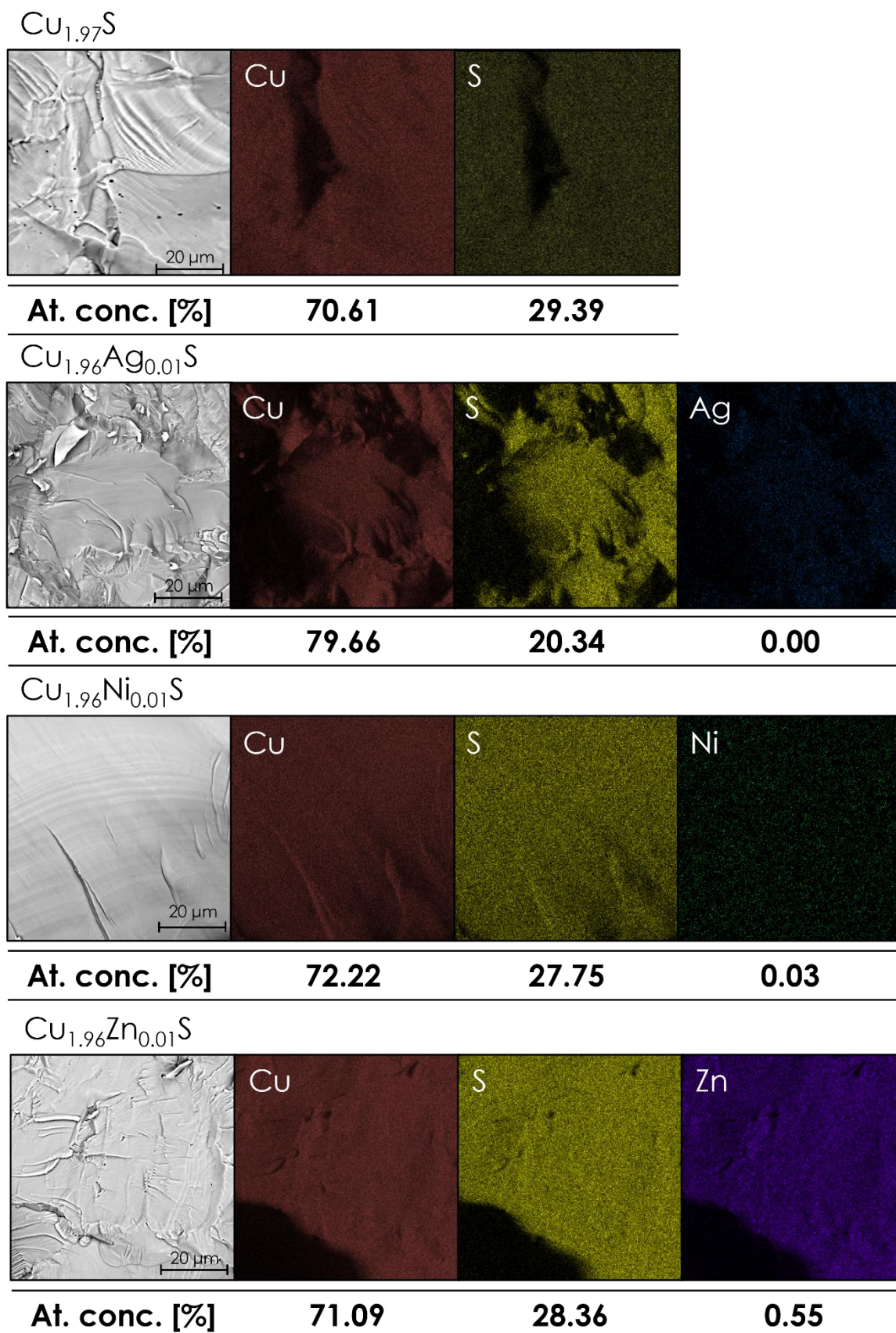


Figure S1. SEM+EDX analysis of $\text{Cu}_{1.97-x}\text{M}_x\text{S}$ ($\text{M} = \text{Ag}, \text{Ni}, \text{Zn}; x = 0, 0.01$) ingots.

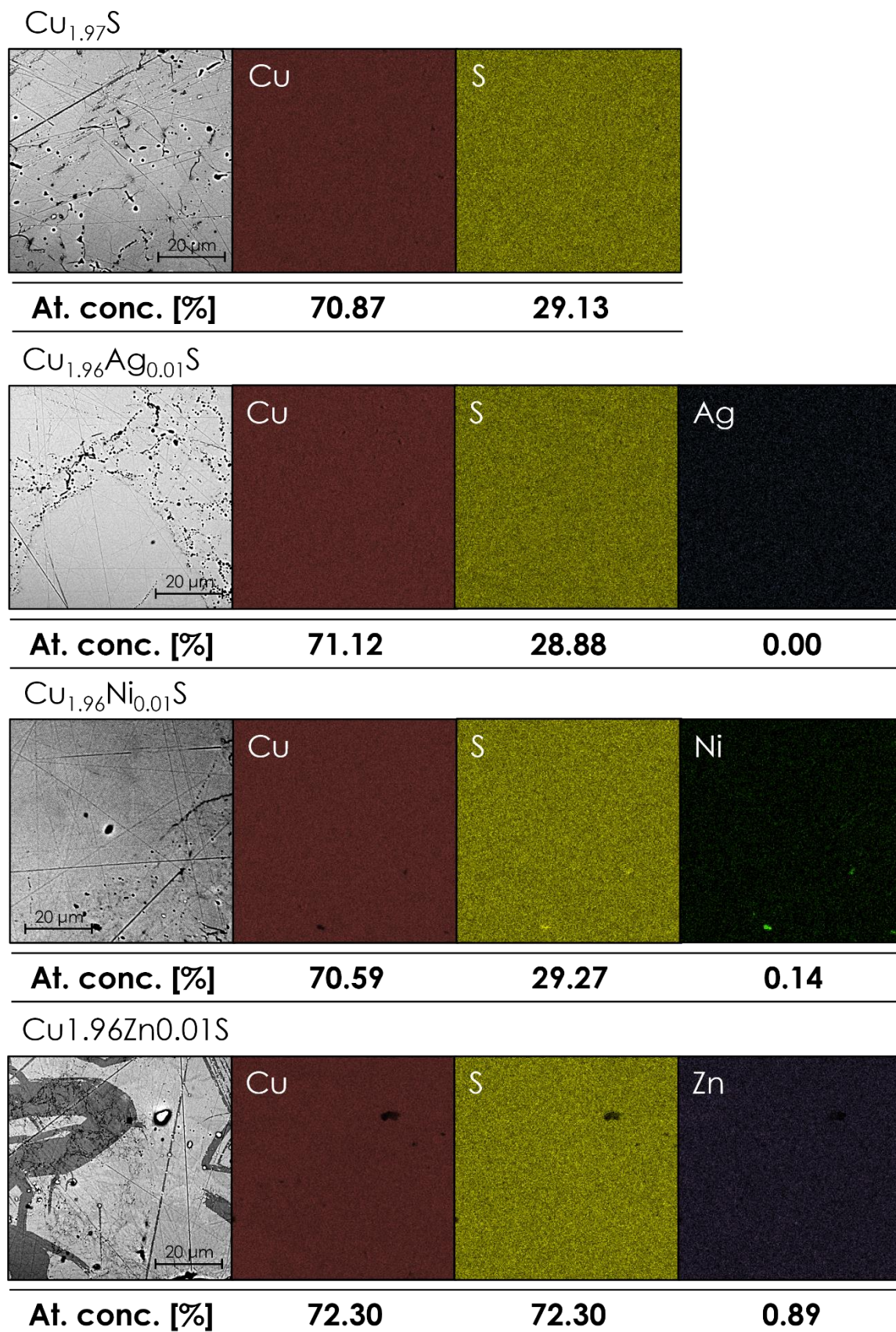
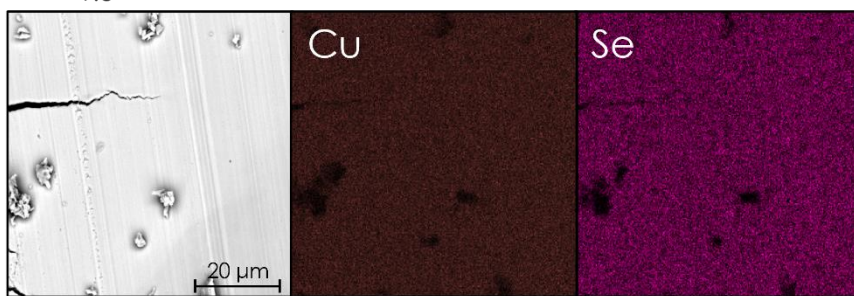
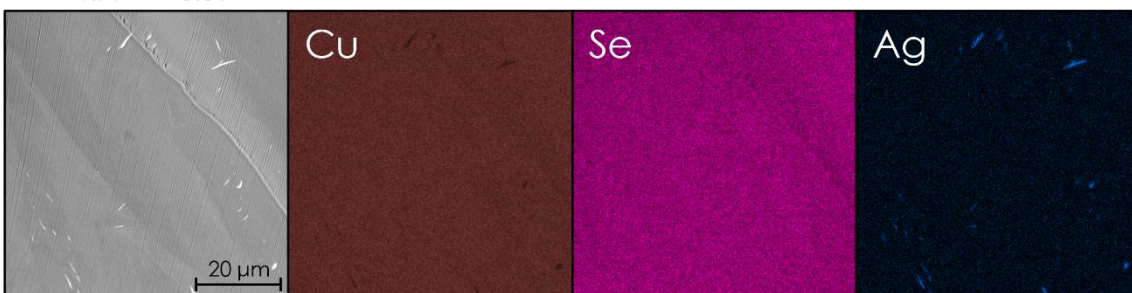


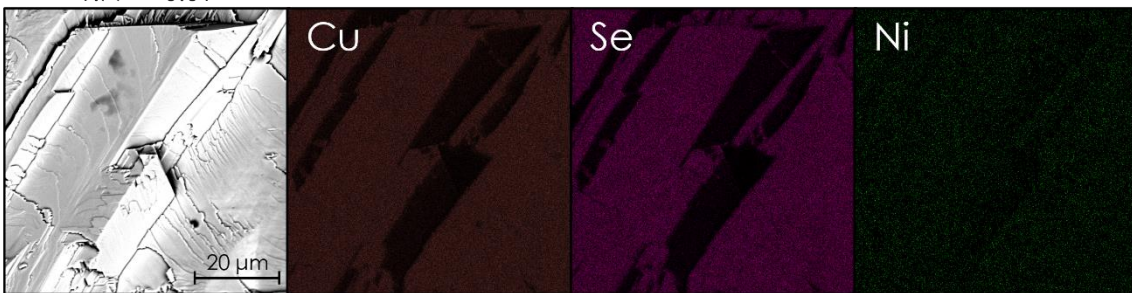
Figure S2. SEM+EDX analysis of $\text{Cu}_{1.97-x}\text{M}_x\text{S}$ ($\text{M} = \text{Ag}, \text{Ni}, \text{Zn}$; $x = 0, 0.01$) pellets.



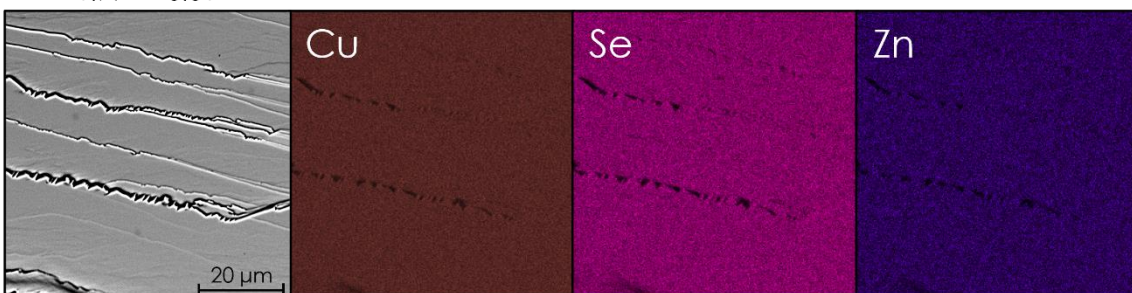
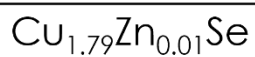
At. conc. [%]	55.78	44.22
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At. conc. [%]	60.60	39.13	0.26
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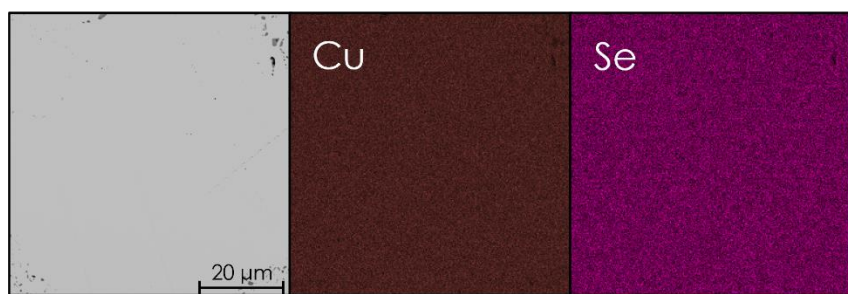
At. conc. [%]	59.94	40.06	0.00
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At. conc. [%]	57.15	42.54	0.31
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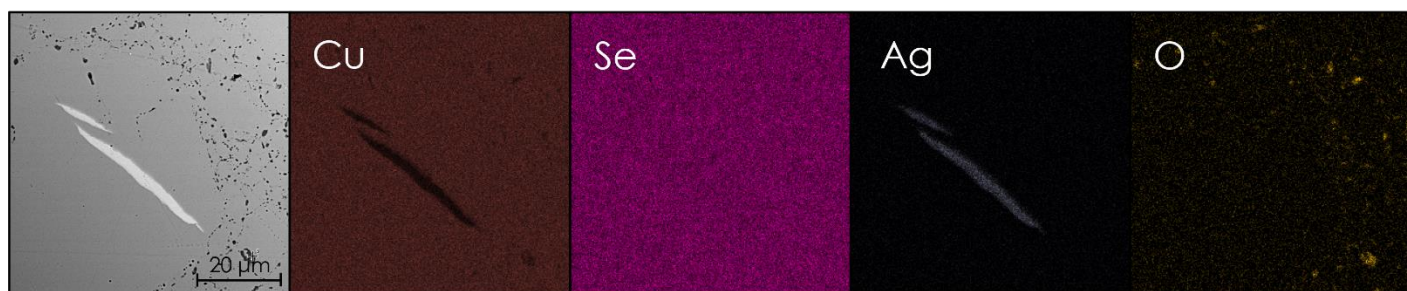
Figure S3. SEM+EDX analysis of $\text{Cu}_{1.8-x}\text{M}_x\text{Se}$ ($\text{M} = \text{Ag}, \text{Ni}, \text{Zn}; x = 0, 0.01$) ingots.

$\text{Cu}_{1.8}\text{Se}$



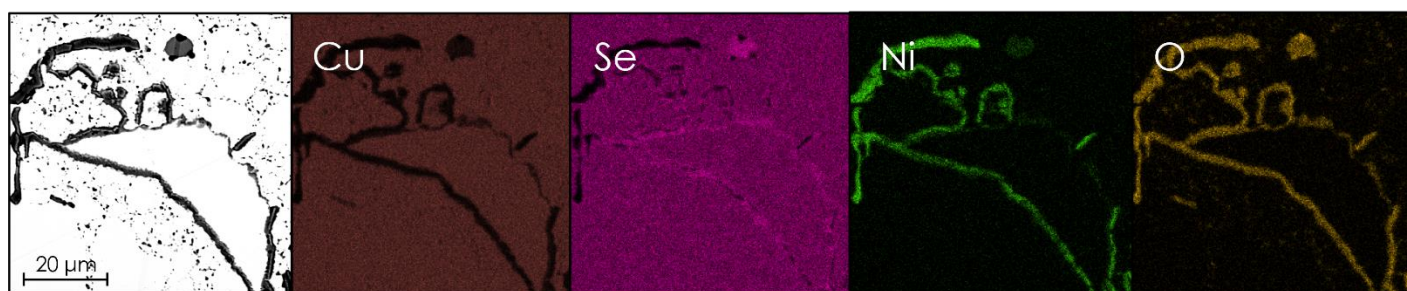
At. conc. [%]	59.17	40.83
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$\text{Cu}_{1.79}\text{Ag}_{0.01}\text{Se}$



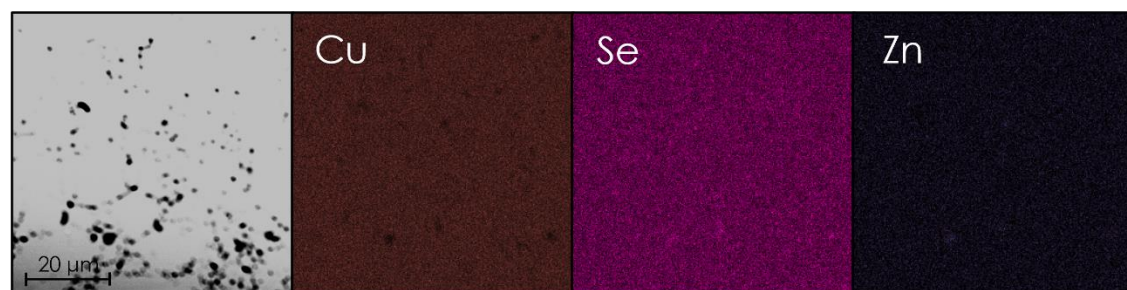
At. conc. [%]	55.61	39.99	1.17	3.32
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$\text{Cu}_{1.79}\text{Ni}_{0.01}\text{Se}$



At. conc. [%]	46.97	35.60	4.74	12.69
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$\text{Cu}_{1.79}\text{Zn}_{0.01}\text{Se}$



At. conc. [%]	58.25	41.31	0.44
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Figure S4. SEM+EDX analysis of $\text{Cu}_{1.8-x}\text{M}_x\text{Se}$ ($\text{M} = \text{Ag}, \text{Ni}, \text{Zn}$; $x = 0, 0.01$) pellets.

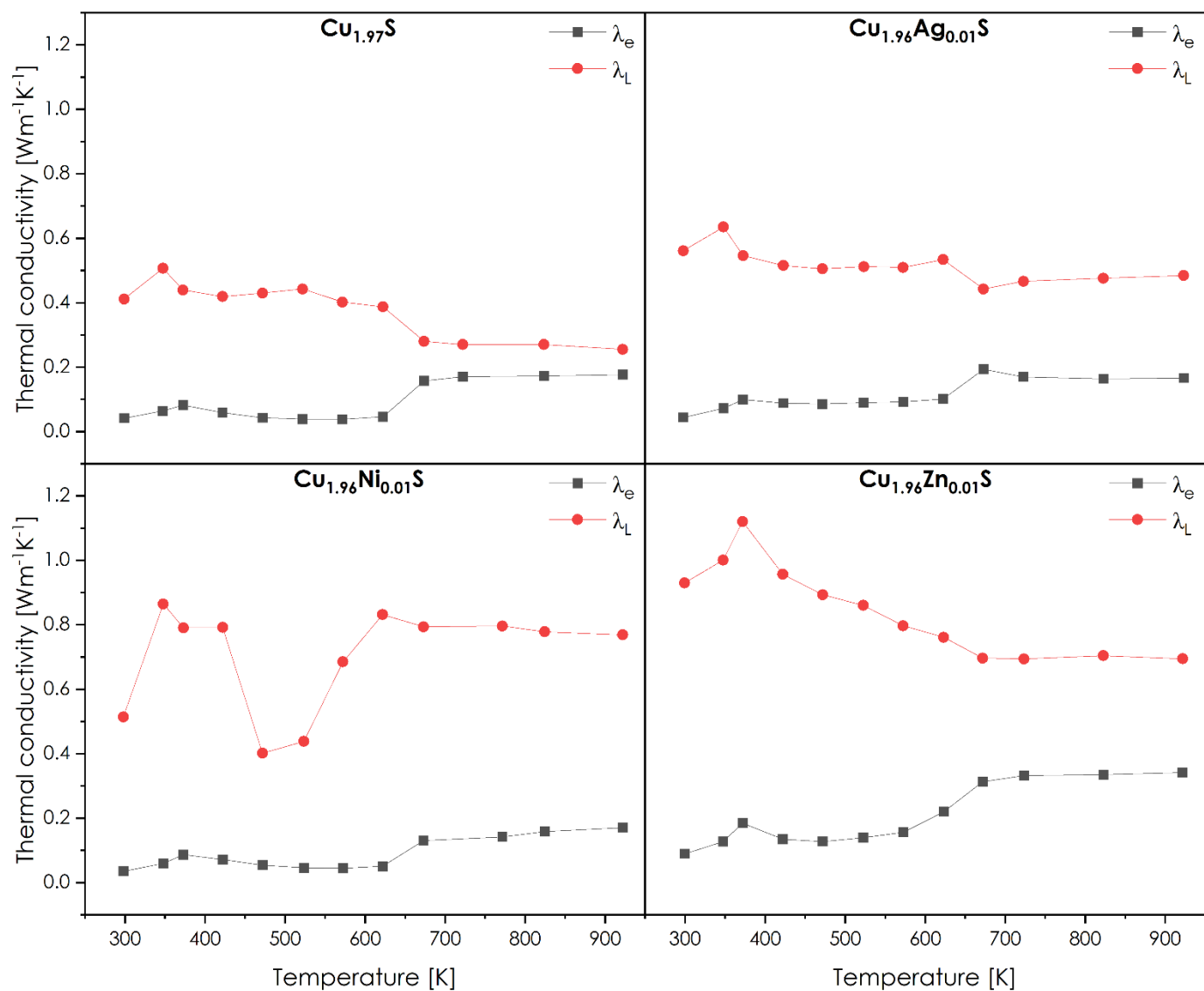


Figure S5. Lattice and electronic components of thermal conductivity as a function of temperature for copper (I) sulfides.

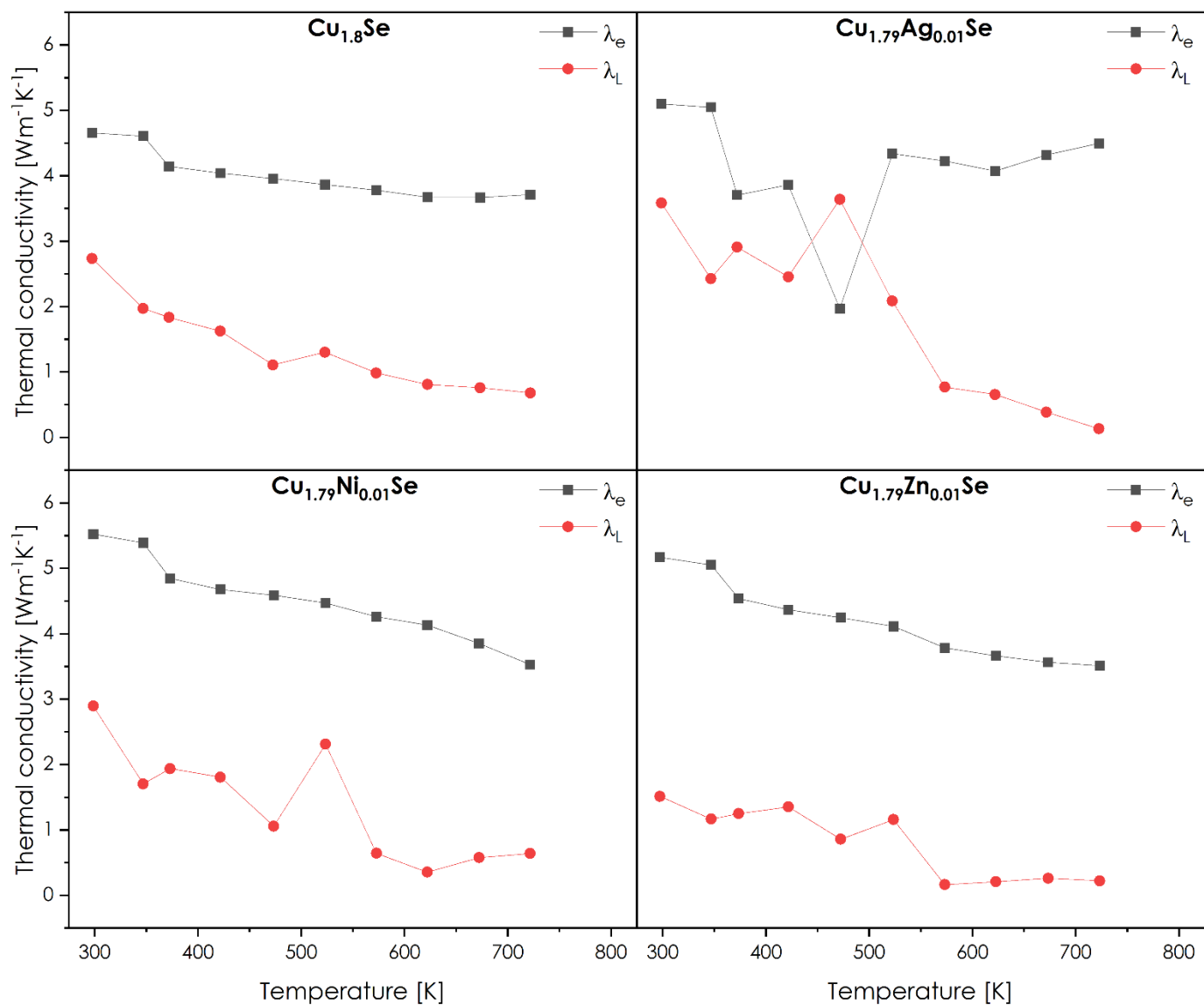


Figure S6. Lattice and electronic components of thermal conductivity as a function of temperature for copper (I) selenides.

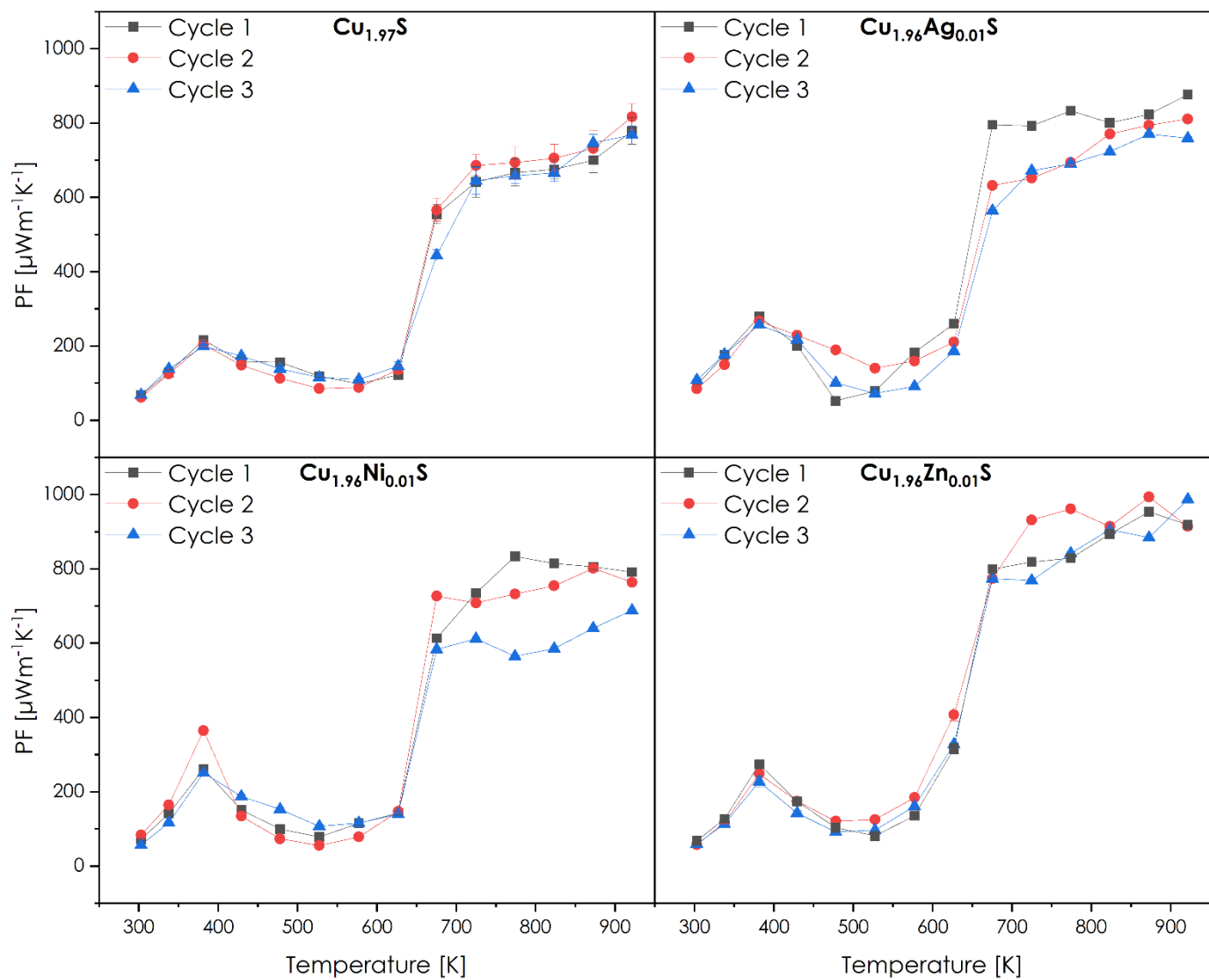


Figure S7. Power factor as a function of temperature for copper(I) sulfides.

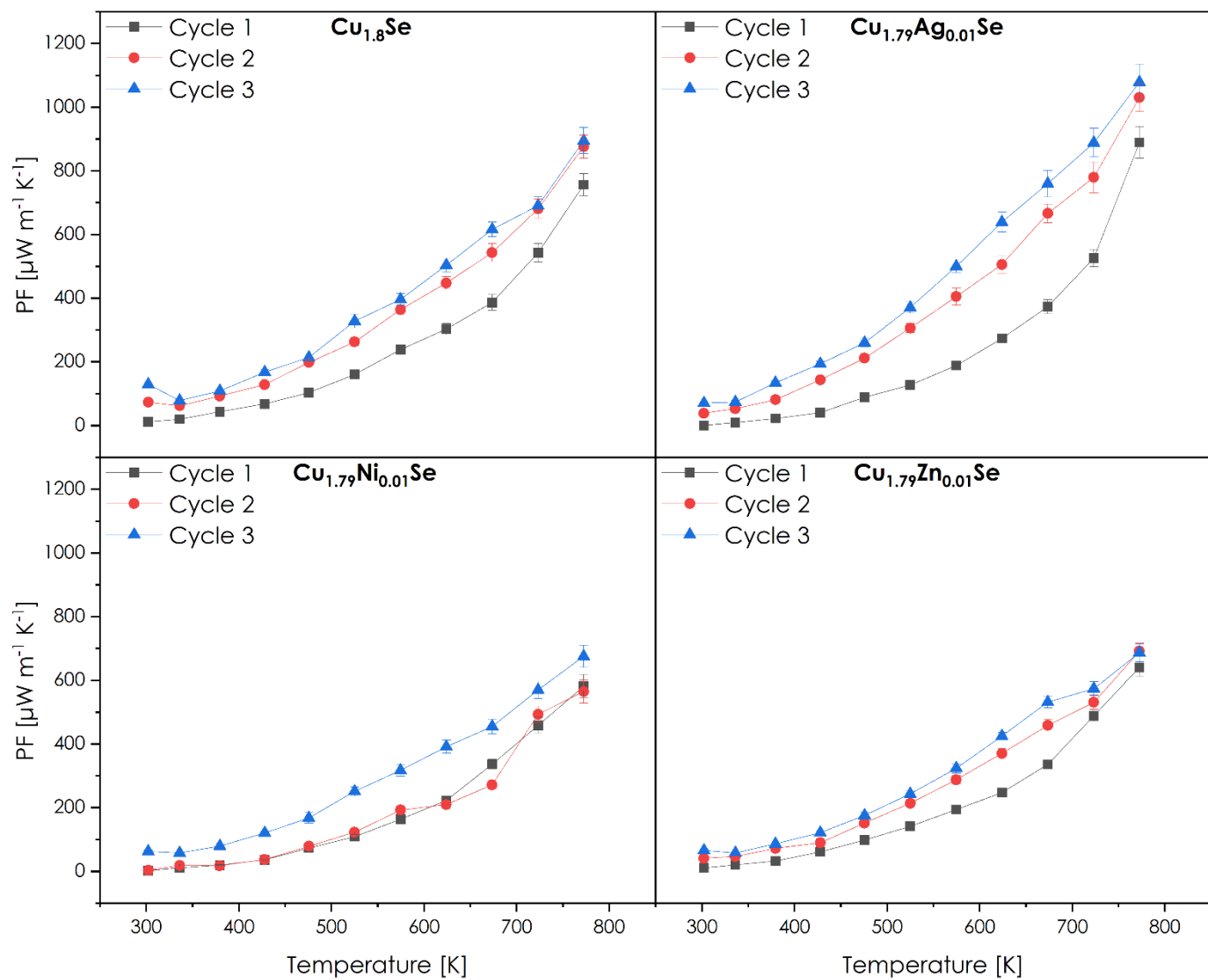


Figure S8. Power factor as a function of temperature for copper(I) selenides.

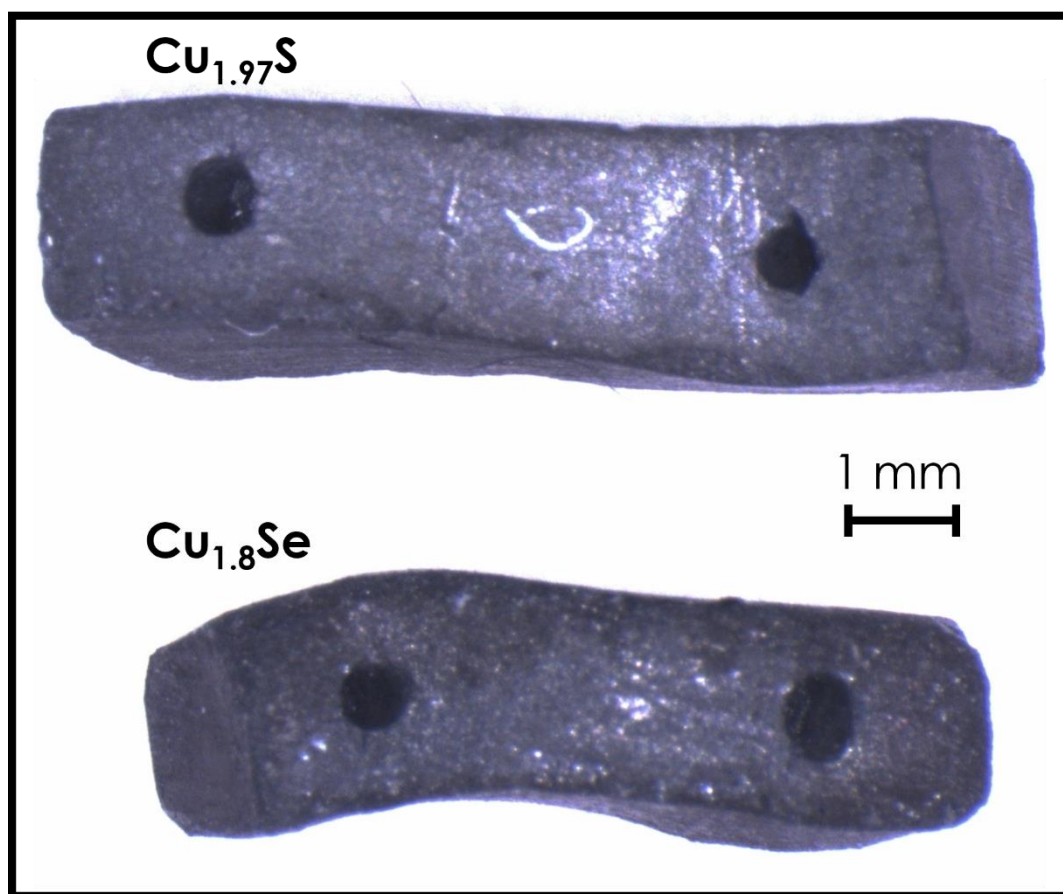


Figure S9. Optical microscope images of $\text{Cu}_{1.97}\text{S}$ and $\text{Cu}_{1.8}\text{Se}$ after TE measurements.